High Temperature CVD system

Oxidation system for VCSELs production

CVD system for SiC (HTC3100)



CVD system for SiC (HTC3100), supplied to National Institute of Advanced Industrial Science and Technology

Reactor : Vertical type, Made of quartz

Face down

Load-lock system : With transfer rod

 Substrate size : 1×σ3°

Substrate heating : RF heating type ■ Maximum heating : 1800°C (Pyrometer value)

temperature

: SiC, etc.

All-in-one CVD system



All-In-One CVD system supplied to Nara Institute of

Reactor Horizontal type, Made of quartz

Substrate size $1 \times \phi 2$

Substrate heating : RF heating type

■ Maximum heating : 1500°C (Pyrometer value)

temperature Foot print

 $1.3m \times 1.3m$: SiC, etc.

Applications

iVOX3001 (with monitoring system) / VOX3001



Substrate heating : Resistance heating type

Maximum heating : 600°C (T.C. Value for control)

temperature Flow control

Oxidation ability

Liquid mass flow control : Heating type Vaporizer (Max.180℃)

Vaporizer Vacuum exhaust : Diaphragm pump

system

Control system

Programmable Logic controller : Uniformity $20 \mu m \pm 0.2 \mu m$

(except for the edge of tray) Reproducibility $20 \mu \text{m} \pm 0.2 \mu \text{m}$

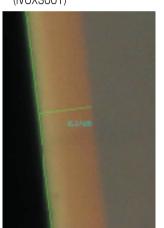
(run to run)

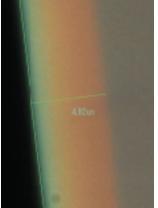
* Depending on the characteristics of

AlAs epitaxial layer

● The Image of Sample: (Magnification: 50x) (iVOX3001)

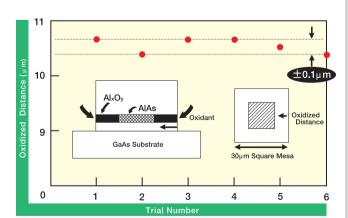






Oxidation time

Oxidation temperature : 450℃
Oxidation temperature : 450℃ : 1 Omin Oxidation time : 10µm Oxidation length :15µm



■Data offered by courtesy of Tokyo Institute of Technology (Jpn. J. Appl. Phys. Vol. 39(2000)PP. 3468-3469)

Ultra High Temperature CVD system (SH2001-HTA)



Ultra High Temperature CVD system (SH2001-HTA) supplied to Meijo University

Horizontal type, Made of stainless steel

Face down Substrate size $1 \times \phi 1$

Substrate heating : Resistance heating type

Maximum heating : 1800℃

temperature

(T.C. Value for control)

High Temperature CVD system / Oxidation system (OV4001)



: Vertical type, Made of stainless steel

Substrate size $1\times\phi4$

Substrate heating : Resistance heating type ■ Maximum heating : 1400°C (T.C. Value for control)

temperature

Applications : Oxidation for SiC, etc.

Applications : AIN, etc.

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